

# Compliance points for XLAUI/CAUI with connector

Piers Dawe  
Avago Technologies

# Supporters

Scott Kipp

Chris Cole

Ryan Latchman

Mike Dudek

Jeffery Maki

Tom Palkert

Frank Chang

Mark Marlett

Brocade

Finisar

Gennum

JDSU

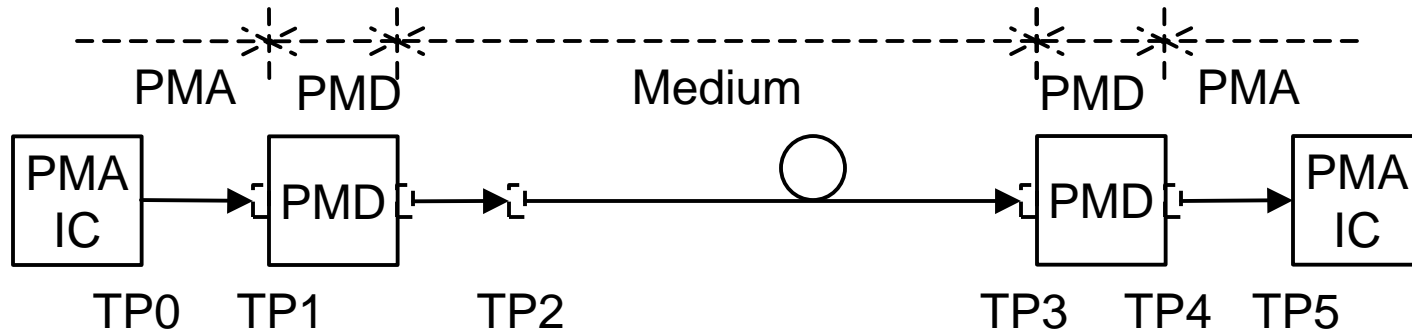
Juniper

Luxtera

Vitesse

Xilinx

# The basics



- Example: simplified test points for an optical link
  - e.g. Gigabit Ethernet with GBIC, Fibre Channel with SFP, 40GBASE-SR4 or 100GBASE-SR10 ("SRn") with PPI
  - All parts of the link are within a sublayer or the medium. There is no "no-mans-land".
  - Compliance points **MUST** be somewhere measurable
  - Compliance points relate to a connector
    - If you can't unplug something and plug in an alternative, you don't know or care what the analog signal is there
    - If the PCB loss is small enough (Gigabit Ethernet) and there are no skew specs, the difference between TP0 and TP1 doesn't matter

TP2 is displaced from the MDI to get a more consistent measurement. The signal at TP2 is representative of the effective signal launched into the fibre.

# Purpose of test points

- For compliance testing
  - Must be accessible
  - S-parameters e.g. reflection, transmission specs of a cable
    - Microwave de-embedding is feasible; measurement can be done at a distance to specification point
  - Including sensitivity, eye diagrams and similar with nonlinear electrical-optical converters (PMDs, optical modules)
    - Microwave style de-embedding is not feasible
- For interoperability
  - Must be related to connectors
- For precise results
  - As frequencies increase and higher performance product is specified, have to be more particular about test point definition
  - See backup for test points used in other projects

# Electrical connector is significant

- Connector provides something that can be unplugged to observe the signals – a compliance point
- Connector probably has better reflections than IC package but worse(?) crosstalk
- But even if better, it's still additional impairment

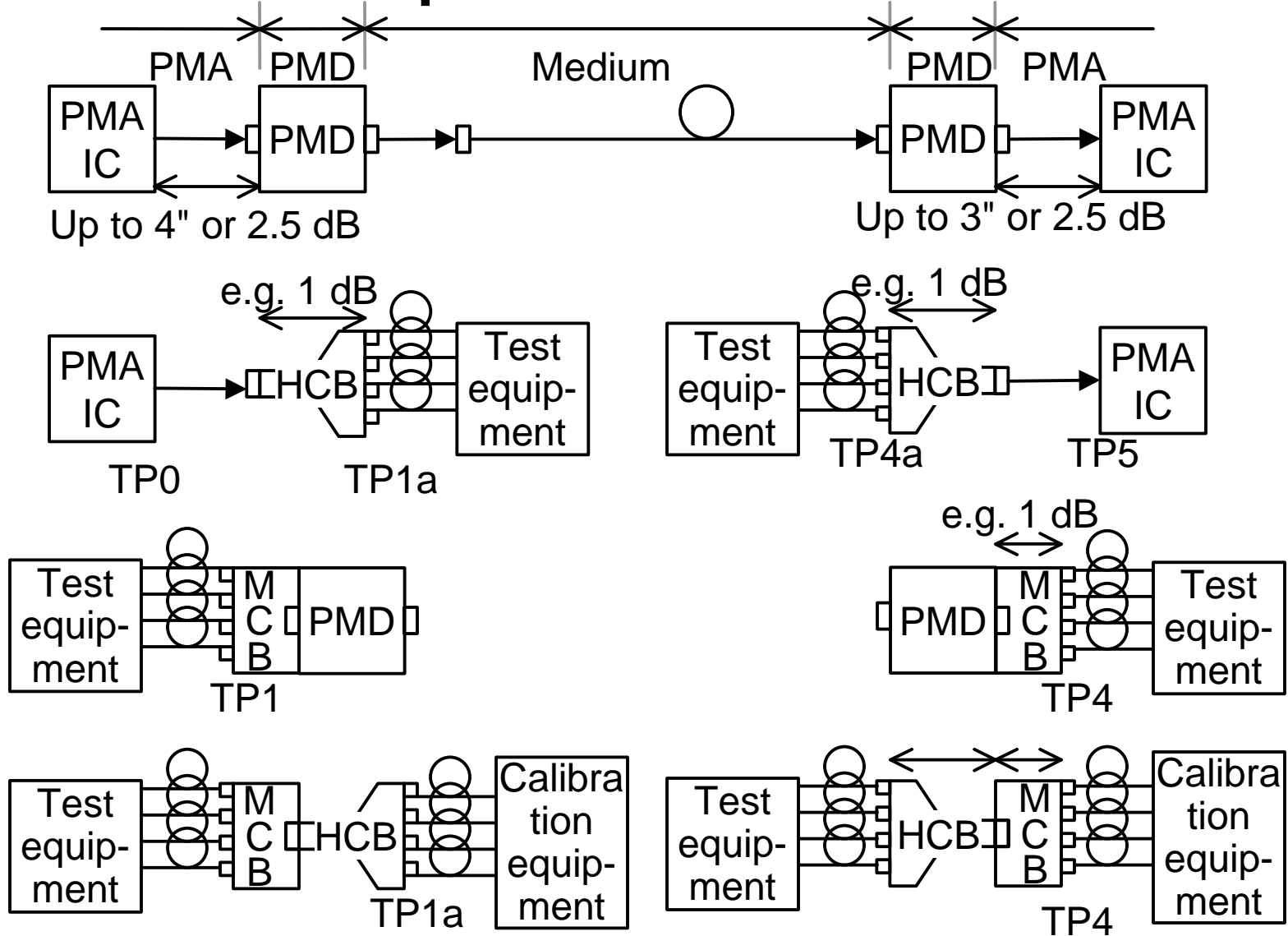
# Comparison of connector and IC specs

At 5.15625 GHz	Reflection (max, dB)	Near end crosstalk (max, dB)
nAUI compliance point	-6.9	No spec
SFP+ ASIC (informative)	-8.5	No spec
Proposed connector spec (Cole, reflector message)	-21	-36
SFF-8083 (for SFP+)	-14.6	-35 (D1.5)

Connector loss assumed  $\leq 0.5$  dB at 5.15625 GHz

This page is for information – not a proposal

# Compliance boards

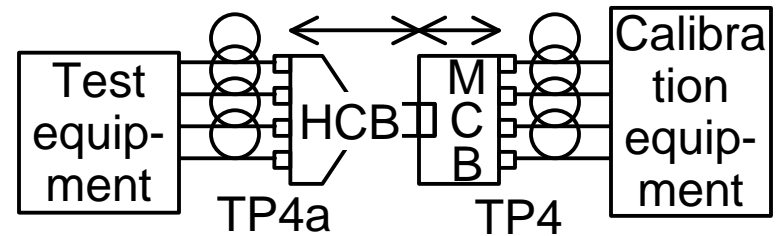
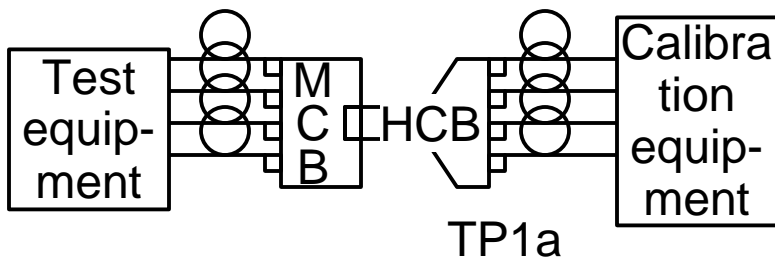
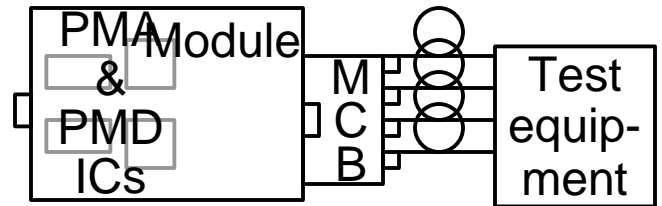
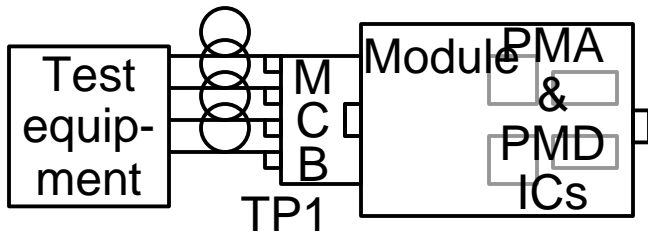
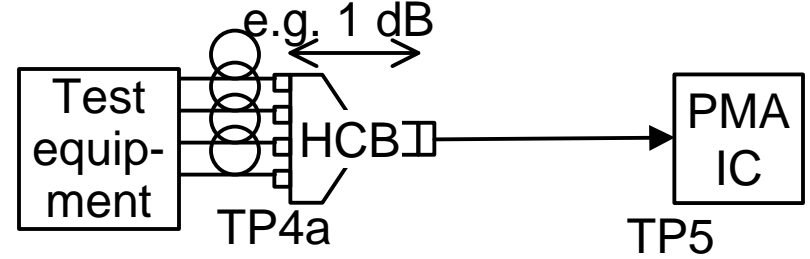
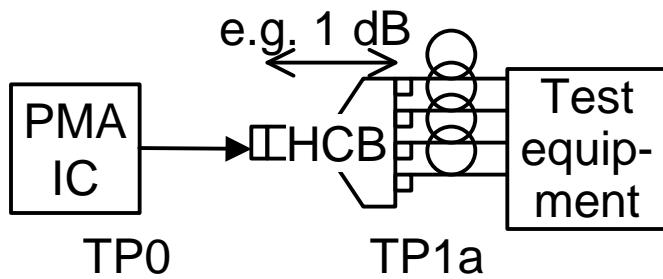
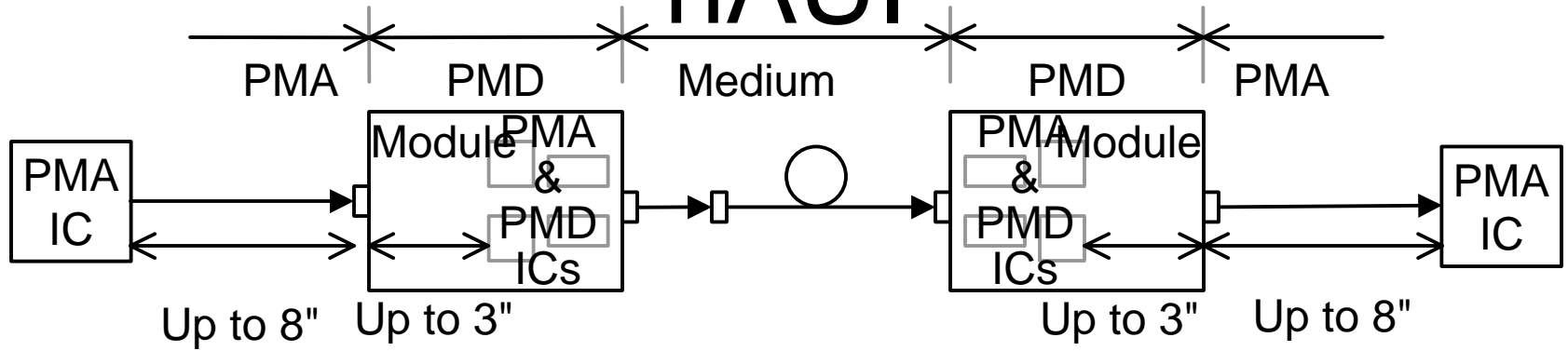


# Compliance boards – notes

- Host Compliance Board (HCB) and MCB (Module Compliance Board) convert between module connector format and instrumentation connectors (e.g. SMA)
- Compliance boards have defined S-parameters
  - Not representing the product PCB loss but a small loss that can be conveniently and reproducibly made
  - Between 1 and 1.5 dB at Nyquist frequency (5.15625 GHz)
- Cannot de-embed PCB losses for e.g. eye and sensitivity measurements. Cannot ignore test board loss
  - This is the reason that compliance board approach is necessary
- Coax cable loss/in is much less than test board loss/in
  - This is the underlying reason why compliance board approach is useful
- Signals are defined after the connector, always
- Reflective S-parameters of sublayer under test are defined looking through compliance board at sublayer (a PMA for nAUI) under test



# nAUI



This slide corrected: PMA in module shown

# nAUI – notes

- Compliance points are not far from the PMD IC
- Compliance points could be far from the PMA IC
- Compliance points as defined for PPI are very suitable
  - No need for new definitions
  - Hope that the compliance board losses can be the same as for PPI, even if connector is physically different
- Compliance board specs are electrical only – do not define product electrical connector choice

# nAUI loss budget

- PCB loss within PMA is a private matter between IC implementer and host PCB implementer
- Standard can recommend no more than the loss of 3" in the module
  - Variously estimated as 1.7 dB to 2.6 dB
- And 8" in the host
  - 4.6 to 7 dB
  - But implementers will try to stretch the length
- Proposed reference budget at 5.15625 GHz
  - Module PCB                      3"            2.5 dB
  - Module connector               -            0.5 dB
  - Host PCB                         8"            7 dB
  - Total                                           10 dB

# How to spec the signal

- On transmit side,
  - Signal at compliance point is similar to signal at point of use because loss between them is small
  - An open eye at TP1a is enough to ensure a usable signal at PMD's point of use
  - But point of generation could be significantly displaced (upstream) by frequency-dependent loss
  - Implies quite a lot of emphasis at TP0: will this cause too much crosstalk? SFP+ does this, for 6.5 dB loss budget but much more demanding jitter requirements
  - If necessary, could let the observed eye be slower
- On receive side
  - Signals could be significantly displaced by frequency-dependent loss
    - Do we want to require the eye at the connector to have a minimum (pre)-emphasis?
    - Should not fully compensate the lossiest channel because of crosstalk

# How complicated an implementation?

- We don't specify these but we make assumptions to write signal specs
- 1-tap emphasis at each driver and 1-tap DFE at each receiver expected to work
- The 1-tap DFE in module (PMD transmit-side receiver) could be deleted (as assumed in SFP+) as an implementation choice
  - e.g. if module traces have low loss
  - Does the same go for module receive-side driver?
    - Two? transmit emphasis settings programmed into ICs
      - Factory knows the PCB the IC has been soldered into
    - Two (in practice often one) receiving 1-tap DFEs
      - Need to tolerate the loss from the connector
      - Could tune autonomously (adaptive), could be set by manufacturer

# Options for specifying emphasis

- Add TWDP and UJ specs on receive side
  - We know how to do this – used in 8G Fibre Channel
  - Use PRBS9, waveform capture and analysis
  - Use a software representation of the 8" PCB
    - Do we need both with and without software channel?
      - Just post-processing, not another measurement
  - Do we need a Qsq spec also?
- Or, specify emphasis via overshoot
  - Also could use PRBS9
  - Doesn't relate so directly to usable performance
  - Need UJ and/or Qsq specs
- Other options?

# What if there isn't a connector?

- If there's no connector, implementer can do as he pleases because compliance tests can't catch him out
- But can use ICs intended for use with connector
- Suggestion: make evaluation boards for each IC with part of expected PCB loss + compliance board loss
  - The two parts of loss add up to actual PCB loss
  - Implementer gets to choose where his observation point is: near one end, or the other, or the middle
- Either: if meet the specs, it's OK to  $10^{-12}$
- Or: if meet the specs with margin, it's OK to  $10^{-15}$
- $10^{-15}$  not an Ethernet objective – don't write about it in 802.3 standard
- If 2 connectors: pick one as the compliance connector and proceed
  - Connectors and/or ICs have to be proportionately better to meet the specs

# Conclusions

- Compliance Board methodology is ideal for nAUI-with-connector spec
- A total loss budget of 10 dB is a good starting point
- Transmit side signal can be specified by "conventional" (not equalisation-aware) methods
- Receive side signal needs a little more
  - Recent successful experience in SFP+ and 8G Fibre Channel can guide us quickly to a good specification



# Backup

- Next two slides describe the test points used in Gigabit Ethernet, Fibre Channel, SFP+ and XFP
- See also [http://ieee802.org/3/ba/public/sep08/dudek\\_01\\_0908.pdf](http://ieee802.org/3/ba/public/sep08/dudek_01_0908.pdf) which contains more diagrams of SFP+ compliance board use

# Background 1/2

- TP1, TP2, TP3, TP4 in Clause 38 (Gigabit Ethernet) is well known
    - TP1, electrical: host output, module input
    - TP2, module optical output
      - Actually, 2 m after the MDI
    - TP3: module optical input
    - TP4, electrical: module output, host input
    - TP0, TP5 have been used informally for a some time (at IC within host)
  - Clause 39, CX4, also has TP1, TP2, TP3, TP4 (all electrical)
    - TP1: upstream of transmit MDI
    - TP2: just downstream of transmit MDI
    - TP3: just upstream of receive MDI
    - TP4: downstream of receive MDI
- "It is expected that in many implementations TP1 and TP4 will be common between 1000BASE-SX (Clause 38), 1000BASE-LX (Clause 38), and 1000BASE-CX"

# Background 2/2

- Fibre Channel up to 4GFC has alpha gamma delta ( $\alpha_T \delta_T \gamma_T \gamma_R \delta_R \alpha_R$ )
  - For an optical link,
    - $\alpha_T$ : Output of IC in host
    - $\delta_T$ : host output, module input, just upstream or just downstream of module transmit electrical connector
      - Depending on what is to be tested
    - $\gamma_T$ : module optical output, 2 m after the MDI
    - $\gamma_R$ : module optical input
    - $\delta_R$ : module output, host input, just upstream or downstream of module receive electrical connector
      - Depending on what is to be tested
- For 8GFC, "just upstream or just downstream" is taken to mean the input or output of a compliance board with a defined electrical loss
- SFP+ compliance points are the same as 8GFC but with different names
- XFP compliance points are earlier, less thorough, version of SFP+'s